# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

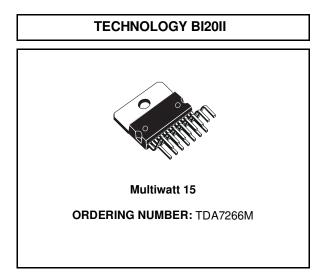




### **TDA7266M**

### 7W MONO BRIDGE AMPLIFIER

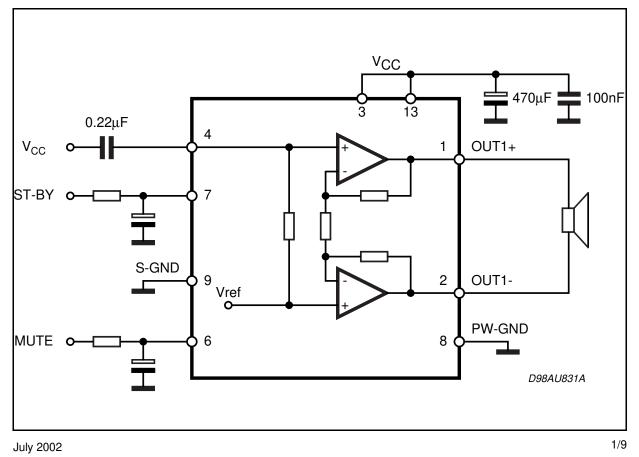
- WIDE SUPPLY VOLTAGE RANGE (3-18V)
- MINIMUM EXTERNAL COMPONENTS
  - NO SWR CAPACITOR
  - NO BOOTSTRAP
  - NO BOUCHEROT CELLS
    INTERNALLY FIXED GAIN
- STAND-BY & MUTE FUNCTIONS
- SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION



#### DESCRIPTION

The TDA7266M is a mono bridge amplifier specially designed for TV and Portable Radio applications.

#### **BLOCK AND APPLICATION DIAGRAM**



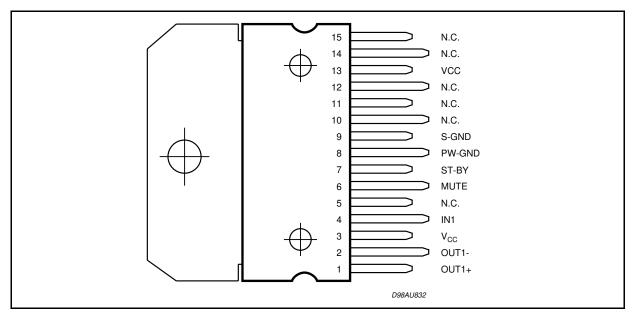
#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Vs	Supply Voltage	20	V
lo	Output Peak Current (internally limited)	2	А
P <sub>tot</sub>	Total Power Dissipation ( $T_{case} = 70^{\circ}C$ )	33	W
T <sub>op</sub>	Operating Temperature	0 to 70	°C
T <sub>stg</sub> , T <sub>j</sub>	Storage and Junction Temperature	-40 to +150	°C

#### THERMAL DATA

Symbol	Description		Value		
R <sub>th j-case</sub>	Thermal Resistance Junction to case	Тур. 1.4	Max. 2	°C/W	

#### PIN CONNECTION (Top view)



## **ELECTRICAL CHARACTERISTICS** (V<sub>CC</sub> = 11V, R<sub>L</sub> = 8 $\Omega$ , f = 1kHz, T<sub>amb</sub> = 25°C unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Vcc	Supply Range		3	11	18	V
lq	Total Quiescent Current			50	65	mA
Vos	Output Offset Voltage				120	mV
Po	Output Power	THD = 10%	6.3	7		W
THD	Total Harmonic Distortion	$P_0 = 1W$		0.05	0.2	%
		$P_{O} = 0.1W$ to 2W f = 100Hz to 15kHz			1	%
SVR	Supply Voltage Rejection	f = 100Hz VR = 0.5V	40	56		dB
A <sub>MUTE</sub>	Mute Attenuation		60	80		dB
Tw	Thermal Threshold			150		°C
Gv	Closed Loop Voltage Gain		25	26	27	dB
Ri	Input Resistance		25	30		KΩ
VT <sub>MUTE</sub>	Mute Threshold	for $V_{CC}$ > 6.4V; $V_O$ = -30dB for $V_{CC}$ < 6.4V; $V_O$ = -30dB	2.3 V <sub>CC</sub> /2 -1	2.9 V <sub>CC</sub> /2 -0.75	4.1 V <sub>CC</sub> /2 -0.5	V V

#### ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
VT <sub>ST-BY</sub>	St-by Threshold		0.8	1.3	1.8	V
I <sub>ST-BY</sub>	ST-BY current V6 = GND				100	μA
e <sub>N</sub>	Total Output Noise Voltage	A curve f = 20Hz to 20kHz		150		μV

#### **APPLICATION SUGGESTION**

#### STAND-BY AND MUTE FUNCTIONS

#### (A) Microprocessor Application

In order to avoid annoying "Pop-Noise" during Turn-On/Off transients, it is necessary to guarantee the right St-by and mute signals sequence. It is quite simple to obtain this function using a mi-

croprocessor (Fig. 1 and 2). At first St-by signal (from mP) goes high and the voltage across the St-by terminal (Pin 7) starts to

increase exponentially. The external RC network is intended to turn-on slowly the biasing circuits of

Figure 1: Microprocessor Application

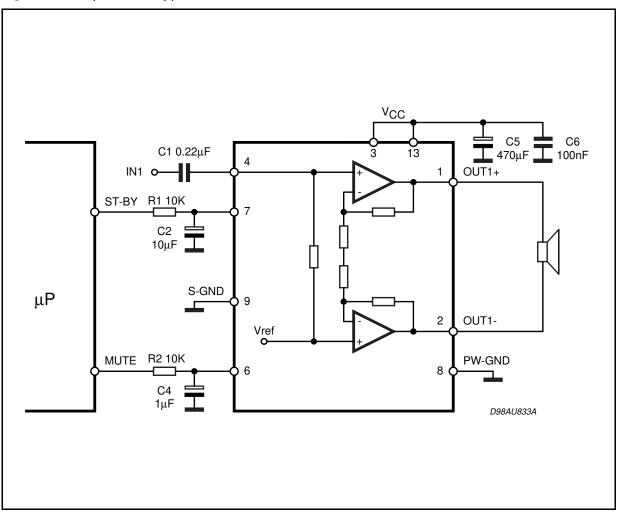
51

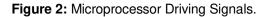
the amplifier, this to avoid "POP" and "CLICK" on the outputs.

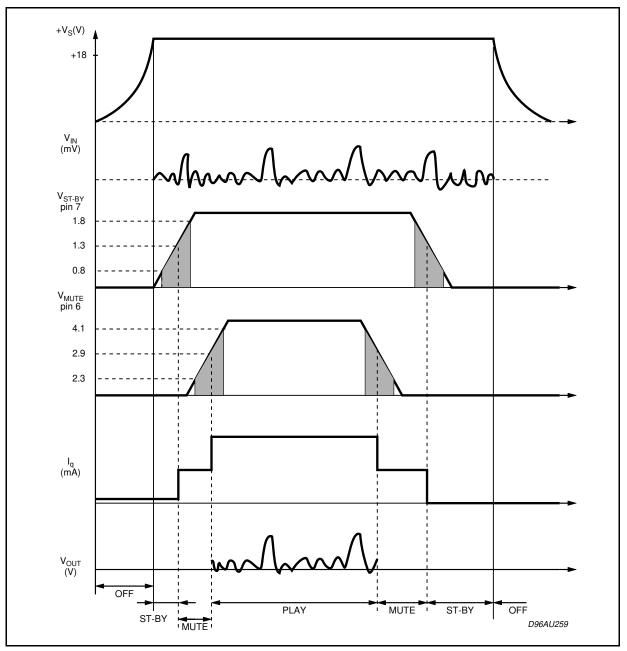
When this voltage reaches the St-by threshold level, the amplifier is switched-on and the external capacitors in series to the input terminals (C3, C5) start to charge.

It's necessary to mantain the mute signal low until the capacitors are fully charged, this to avoid that the device goes in play mode causing a loud "Pop Noise" on the speakers.

A delay of 100-200ms between St-by and mute signals is suitable for a proper operation.





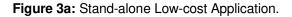


#### (B) Low Cost Application

In low cost applications where the mP is not present, the suggested circuit is shown in fig.3.

The St-by and mute terminals are tied together and they are connected to the supply line via an external voltage divider.

The device is switched-on/off from the supply line and the external capacitor C4 is intended to delay the St-by and mute threshold exceeding, avoiding "Popping" problems.



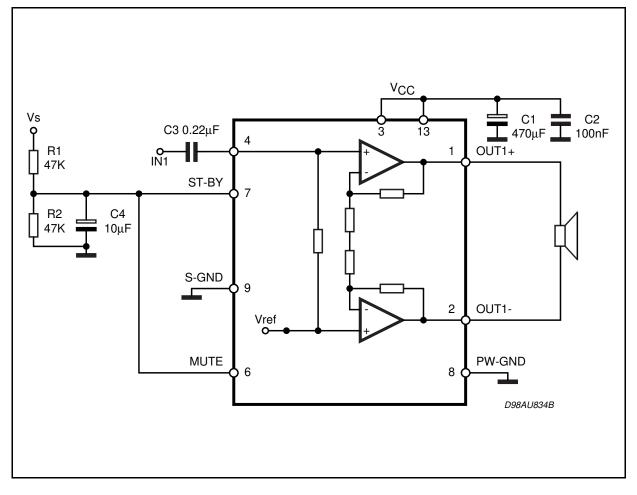
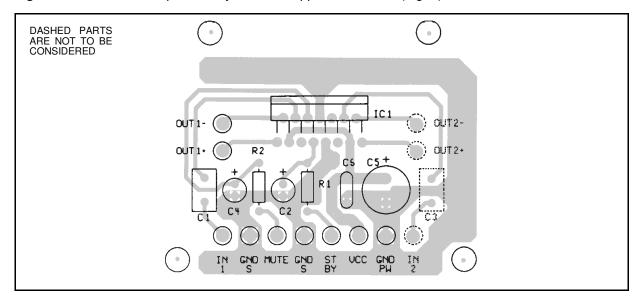
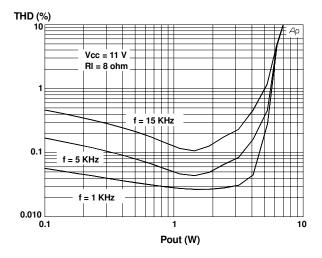


Figure 3b: PCB and Component Layout of the Application Circuit (Fig. 1).

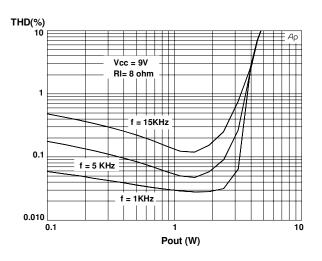


57

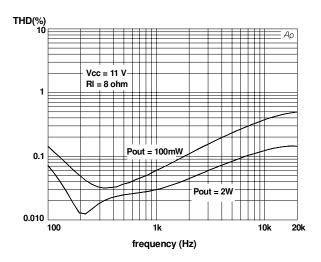
#### Figure 4: Distortion vs Output Power

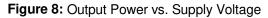


#### Figure 5: Distortion vs Output Power



#### Figure 6: Distortion vs Frequency





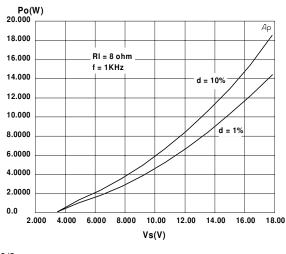
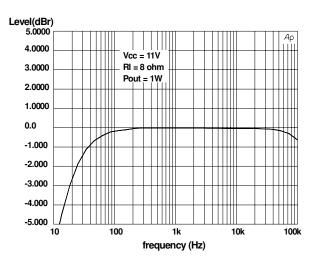
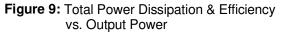
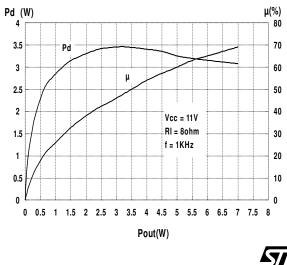


Figure 7: Gain vs Frequency







#### Figure 10: Mute Attenuation vs. V pin.6

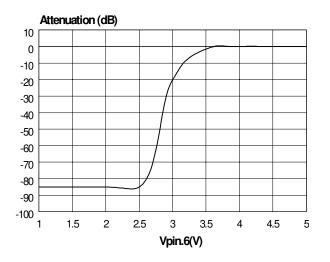


Figure 12: Quiescent Current vs. Supply Voltage

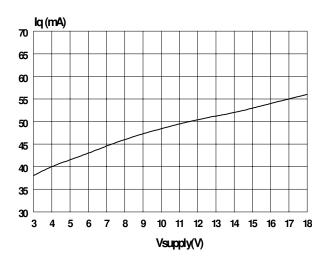
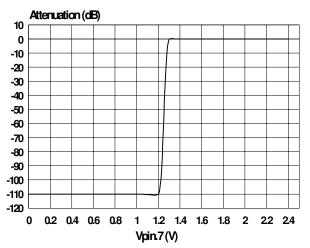
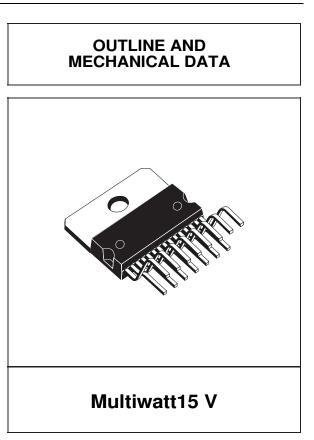
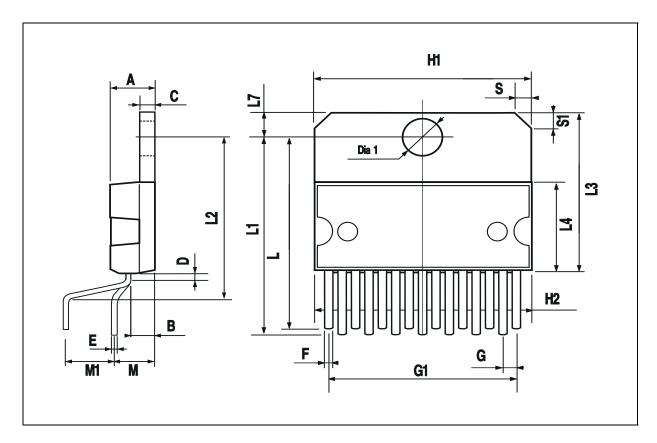


Figure 11: Stand-By Attenuation vs Vpin.7



DIM.	mm			inch			
DINI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А			5			0.197	
В			2.65			0.104	
С			1.6			0.063	
D		1			0.039		
Е	0.49		0.55	0.019		0.022	
F	0.66		0.75	0.026		0.030	
G	1.02	1.27	1.52	0.040	0.050	0.060	
G1	17.53	17.78	18.03	0.690	0.700	0.710	
H1	19.6			0.772			
H2			20.2			0.795	
L	21.9	22.2	22.5	0.862	0.874	0.886	
L1	21.7	22.1	22.5	0.854	0.870	0.886	
L2	17.65		18.1	0.695		0.713	
L3	17.25	17.5	17.75	0.679	0.689	0.699	
L4	10.3	10.7	10.9	0.406	0.421	0.429	
L7	2.65		2.9	0.104		0.114	
М	4.25	4.55	4.85	0.167	0.179	0.191	
M1	4.63	5.08	5.53	0.182	0.200	0.218	
S	1.9		2.6	0.075		0.102	
S1	1.9		2.6	0.075		0.102	
Dia1	3.65		3.85	0.144		0.152	





**57** 

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specification mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

© 2002 STMicroelectronics - Printed in Italy - All Rights Reserved

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco -Singapore - Spain - Sweden - Switzerland - United Kingdom - United States.

http://www.st.com

57